Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

REMINDERS

Product information in this catalog is as of October 2016. All of the contents specified herein are subject to change without notice due to technical improvements, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual specification.

- Please contact TAIYO YUDEN for further details of product specifications as the individual specification is available.
- Please conduct validation and verification of our products in actual condition of mounting and operating environment before using our products.
- The products listed in this catalog are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC). Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment, disaster prevention equipment, medical equipment, highly public information network equipment including, without limitation, telephone exchange, and base station).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment).

When our products are used even for high safety and/or reliability-required devices or circuits of general electronic equipment, it is strongly recommended to perform a thorough safety evaluation prior to use of our products and to install a protection circuit as necessary.

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

- Please note that TAIYO YUDEN shall have no responsibility for any controversies or disputes that may occur in connection with a third party's intellectual property rights and other related rights arising from use of our products. TAIYO YUDEN grants no license for such rights.
- Please note that unless otherwise agreed in writing, the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a fault or defect in our products.
- The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.
- Caution for Export

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

MULTILAYER CHIP INDUCTORS FOR HIGH FREQUENCY APPLICATIONS(HK SERIES)





*Except for HK0603, HK1005

■PARTS NUMBER

* Operating Temp.:-55~+125°C (HK1608/2125:-40~+85°C)



Н	K	Δ	0	6	0	3	Δ	1	0	Ν	J	_	Т
	1			(2	2				3		4	(5	

△=Blank space

Code	Series name
HK∧	Multilayer chip inductor for high frequency
пкд	applications

②Dimensions (L×W)

EDITIONS (E	* 117	
Code	Type (inch)	Dimensions (L×W)[mm]
0603	0603(0201)	0.6 × 0.3
1005	1005 (0402)	1.0 × 0.5
1608	1608 (0603)	1.6 × 0.8
2125	2125 (0805)	2.0 × 1.2

3 Nominal inductance

Code (example)	Nominal inductance[nH]
3N9	3.9
10N	10.0
R10	100
R12	120

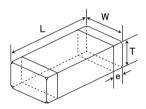
※R=Decimal point N=0.0(nH type)

4 Inductance tolerance

Code	Inductance tolerance
J	±5%
S	±0.3nH

5Packaging	
Code	Packaging
	Taping

STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Туре		w	т		Standard quantity[pcs]				
Туре	L	VV	!	е	Paper tape	Embossed tape			
HK 0603	0.6 ± 0.03	0.3 ± 0.03	0.3 ± 0.03	0.15±0.05	15000	_			
(0201)	(0.024 ± 0.001)	(0.012±0.001)	(0.012 ± 0.001)	(0.006 ± 0.002)	15000	_			
HK 1005	1.0±0.05	0.5 ± 0.05	0.5 ± 0.05	0.25±0.10	10000	_			
(0402)	(0.039 ± 0.002)	(0.020 ± 0.002)	(0.020 ± 0.002)	(0.010 ± 0.004)	10000				
HK 1608	1.6±0.15	0.8±0.15	0.8±0.15	0.3 ± 0.2	4000	_			
(0603)	(0.063 ± 0.006)	(0.031 ± 0.006)	(0.031 ± 0.006)	(0.012±0.008)	4000	_			
	2.0+0.3/-0.1	1.25±0.2	0.85±0.2	0.5±0.3	_	4000			
HK 2125	$(0.079 + 0.012 / -0.004)$ (0.049 ± 0.008)		(0.033 ± 0.008)	(0.020 ± 0.012)	_	4000			
(0805)	$2.0+0.3/-0.1$ 1.25 ± 0.2		1.0+0.2/-0.3	0.5±0.3		3000			
	(0.079 + 0.012 / -0.004)	(0.049 ± 0.008)	(0.039 + 0.008 / -0.012)	(0.020 ± 0.012)	_	3000			

Unit:mm(inch)

[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our specification. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/) .

HK 0603

Parts number	EHS	Nominal inductance	Inductance tolerance ※)	Q (min.)	LQ Measuring frequency	Q(T _s	/pical)	frequ	ency[[MHz]		resonant cy [MHz]	DC Res		Rated current [mA] (max.)	Thickness [mm]
		[nH]	tolerance 💥)	(min.)	[MHz]	100	300	500	800	1000	(min.)	(typ.)	(max.)	(typ.)	[mA] (max.)	[mm]
HK 0603 1N0∏-T	RoHS	1.0	±0.3nH	4	100	6	12	17	22	27	10000	> 13000	0.11	0.088	470	0.30 ±0.03
HK 0603 1N2[]-T	RoHS	1.2	±0.3nH	4	100	6	12	16	21	25	10000	> 13000	0.12	0.089	450	0.30 ±0.03
HK 0603 1N5∏-T	RoHS	1.5	±0.3nH	4	100	6	12	15	20	23	10000	> 13000	0.13	0.11	430	0.30 ± 0.03
HK 0603 1N8∏-T	RoHS	1.8	±0.3nH	4	100	6	12	15	20	23	10000	> 13000	0.16	0.12	390	0.30 ± 0.03
HK 0603 2N0∏-T	RoHS	2.0	±0.3nH	4	100	6	12	15	20	22	10000	> 13000	0.17	0.13	380	0.30 ± 0.03
HK 0603 2N2∏-T	RoHS	2.2	±0.3nH	4	100	6	12	15	20	22	8800	12500	0.19	0.14	360	0.30 ± 0.03
HK 0603 2N4∏-T	RoHS	2.4	±0.3nH	4	100	6	12	15	20	22	8300	11700	0.20	0.15	350	0.30 ± 0.03
HK 0603 2N7∏-T	RoHS	2.7	±0.3nH	5	100	7	12	15	20	22	7700	11000	0.21	0.16	340	0.30 ± 0.03
HK 0603 3N0∏-T	RoHS	3.0	±0.3nH	5	100	7	12	15	20	22	7200	11000	0.22	0.18	330	0.30 ± 0.03
HK 0603 3N3∏-T	RoHS	3.3	±0.3nH	5	100	7	12	15	20	22	6700	9600	0.23	0.19	320	0.30 ± 0.03
HK 0603 3N6∏-T	RoHS	3.6	±0.3nH	5	100	7	12	15	20	22	6400	9100	0.25	0.20	310	0.30 ± 0.03
HK 0603 3N9∏-T	RoHS	3.9	±0.3nH	5	100	7	12	15	20	22	6000	8600	0.27	0.20	300	0.30 ± 0.03
HK 0603 4N3∏-T	RoHS	4.3	±0.3nH	5	100	7	12	15	19	21	5700	8100	0.30	0.22	280	0.30 ± 0.03
HK 0603 4N7∏-T	RoHS	4.7	±0.3nH	5	100	7	12	15	19	21	5300	7600	0.30	0.24	280	0.30 ± 0.03
HK 0603 5N1∏-T	RoHS	5.1	±0.3nH	5	100	7	12	15	19	21	5000	7100	0.33	0.26	270	0.30 ± 0.03
HK 0603 5N6∏-T	RoHS	5.6	±0.3nH	5	100	7	12	15	19	21	4600	6600	0.36	0.27	260	0.30 ± 0.03
HK 0603 6N2∏-T	RoHS	6.2	±0.3nH	5	100	7	11	14	18	20	4200	6100	0.38	0.29	250	0.30 ± 0.03
HK 0603 6N8∏-T	RoHS	6.8	±5%	5	100	7	11	14	18	20	3900	5600	0.39	0.30	250	0.30 ± 0.03
HK 0603 7N5∏-T	RoHS	7.5	±5%	5	100	7	11	14	18	19	3600	5300	0.41	0.34	240	0.30 ± 0.03
HK 0603 8N2∏-T	RoHS	8.2	±5%	5	100	7	11	14	18	19	3400	4900	0.45	0.34	230	0.30 ± 0.03
HK 0603 9N1□-T	RoHS	9.1	±5%	5	100	7	11	14	17	18	3200	4600	0.48	0.40	220	0.30 ±0.03
HK 0603 10N□-T	RoHS	10	±5%	5	100	7	11	14	17	18	2900	4200	0.51	0.41	220	0.30 ±0.03
HK 0603 12N∏-T	RoHS	12	±5%	5	100	7	11	14	17	18	2700	3800	0.68	0.45	190	0.30 ± 0.03
HK 0603 15N∏-T	RoHS	15	±5%	5	100	7	11	13	16	17	2300	3300	0.71	0.50	180	0.30 ± 0.03
HK 0603 18N∏-T	RoHS	18	±5%	5	100	7	11	13	16	17	2100	3000	0.81	0.57	170	0.30 ± 0.03
HK 0603 22N□-T	RoHS	22	±5%	5	100	7	11	13	15	16	1800	2600	1.00	0.71	150	0.30 ±0.03
HK 0603 27N□-T	RoHS	27	±5%	4	100	6	10	12	14	15	1800	2600	1.35	1.11	120	0.30 ±0.03
HK 0603 33N∏-T	RoHS	33	±5%	4	100	6	10	12	14	14	1700	2400	1.47	1.33	110	0.30 ±0.03
HK 0603 39N∏-T	RoHS	39	±5%	4	100	6	10	12	13	12	1500	2100	1.72	1.51	100	0.30 ±0.03
HK 0603 47N[]-T	RoHS	47	±5%	4	100	6	10	11	12	11	1300	1800	1.90	1.74	100	0.30 ±0.03
HK 0603 56N∏-T	RoHS	56	±5%	4	100	6	10	11	11	10	1100	1600	2.27	1.85	80	0.30 ±0.03
HK 0603 68N∏-T	RoHS	68	±5%	4	100	6	10	11	11	10	1100	1500	2.66	2.30	80	0.30 ±0.03
HK 0603 82N[]-T	RoHS	82	±5%	4	100	6	10	11	10	8	1000	1400	3.37	2.60	70	0.30 ±0.03
HK 0603 R10[]-T	RoHS	100	±5%	4	100	6	9	10	9	6	900	1200	3.74	3.00	60	0.30 ±0.03

 ^{★ ☐} mark indicates the Inductance tolerance code. Please refer for the inductance tolerance except the above.

HK 1005

HK 1005																	
		Nominal	Inductance	Q	LQ Measuring	Q(T _y	ypical)) frequ	ency	[MHz]		resonant		sistance 21	Rated [mA]	current (max.)	Thickness
Parts number	EHS	inductance [nH]	tolerance ※)	(min.)	frequency [MHz]	100	300	500	800	1000	(min.)	(typ.)	(max.)	(typ.)	-55 ~ +125°C	-55 ~ +85°C	[mm]
HK 1005 1N0∏-T	RoHS	1.0	±0.3nH	8	100	11	25	34	43	52	10000	> 13000	0.08	0.04	300	900	0.50 ±0.05
HK 1005 1N2[]-T	RoHS	1.2	±0.3nH	8	100	11	25	35	44	52	10000	> 13000	0.09	0.04	300	900	0.50 ±0.05
HK 1005 1N5∏-T	RoHS	1.5	±0.3nH	8	100	11	24	33	44	48	6000	> 13000	0.10	0.05	300	850	0.50 ±0.05
HK 1005 1N8[]-T	RoHS	1.8	±0.3nH	8	100	11	23	30	36	42	6000	11000	0.12	0.06	300	700	0.50 ±0.05
HK 1005 2N0∏-T	RoHS	2.0	±0.3nH	8	100	11	21	27	34	39	6000	10500	0.12	0.06	300	700	0.50 ±0.05
HK 1005 2N2[]-T	RoHS	2.2	±0.3nH	8	100	10	18	25	31	36	6000	10000	0.13	0.07	300	700	0.50 ±0.05
HK 1005 2N4[]-T	RoHS	2.4	±0.3nH	8	100	10	18	24	31	35	6000	9500	0.13	0.07	300	650	0.50 ±0.05
HK 1005 2N7[]−T	RoHS	2.7	±0.3nH	8	100	10	18	24	31	34	6000	9000	0.13	0.08	300	650	0.50 ±0.05
HK 1005 3N0∏-T	RoHS	3.0	±0.3nH	8	100	10	18	24	31	35	6000	8500	0.16	0.09	300	600	0.50 ±0.05
HK 1005 3N3∏-T	RoHS	3.3	±0.3nH	8	100	10	18	24	31	35	6000	8000	0.16	0.10	300	550	0.50 ±0.05
HK 1005 3N6∏-T	RoHS	3.6	±0.3nH	8	100	10	18	24	31	35	5000	7500	0.20	0.11	300	500	0.50 ±0.05
HK 1005 3N9∏-T	RoHS	3.9	±0.3nH	8	100	10	18	24	31	35	4000	7000	0.21	0.12	300	500	0.50 ±0.05
HK 1005 4N3[]-T	RoHS	4.3	±0.3nH	8	100	10	18	24	31	35	4000	6500	0.20	0.12	300	500	0.50 ±0.05
HK 1005 4N7[]−T	RoHS	4.7	±0.3nH	8	100	10	18	24	31	34	4000	6000	0.21	0.12	300	500	0.50 ±0.05
HK 1005 5N1∏-T	RoHS	5.1	±0.3nH	8	100	10	18	24	31	34	4000	5800	0.21	0.13	300	450	0.50 ±0.05
HK 1005 5N6[]-T	RoHS	5.6	±0.3nH	8	100	10	18	24	30	35	4000	5700	0.23	0.15	300	430	0.50 ±0.05
HK 1005 6N2[]-T	RoHS	6.2	±0.3nH	8	100	10	18	24	30	34	3900	5600	0.25	0.16	300	430	0.50 ±0.05
HK 1005 6N8[]-T	RoHS	6.8	±5%	8	100	10	18	23	29	32	3900	5500	0.25	0.17	300	430	0.50 ±0.05
HK 1005 7N5∏-T	RoHS	7.5	±5%	8	100	10	18	23	29	32	3700	5200	0.25	0.18	300	400	0.50 ±0.05
HK 1005 8N2[]-T	RoHS	8.2	±5%	8	100	10	18	23	29	31	3600	4900	0.28	0.21	300	380	0.50 ±0.05
HK 1005 9N1∏-T	RoHS	9.1	±5%	8	100	10	18	23	29	31	3400	4500	0.30	0.22	300	360	0.50 ±0.05
HK 1005 10N∏-T	RoHS	10	±5%	8	100	10	18	23	29	31	3200	4300	0.31	0.23	300	340	0.50 ±0.05
HK 1005 12N∏-T	RoHS	12	±5%	8	100	11	18	23	29	31	2700	3900	0.40	0.28	300	330	0.50 ±0.05
HK 1005 15N∏-T	RoHS	15	±5%	8	100	11	18	23	28	30	2300	3500	0.46	0.31	300	320	0.50 ±0.05
HK 1005 18N∏-T	RoHS	18	±5%	8	100	11	18	23	28	30	2100	3100	0.55	0.35	300	310	0.50 ±0.05
HK 1005 22N∏-T	RoHS	22	±5%	8	100	11	17	22	26	27	1900	2800	0.60	0.42	300	300	0.50 ±0.05
HK 1005 27N□-T	RoHS	27	±5%	8	100	11	17	21	25	26	1600	2300	0.70	0.47	300	300	0.50 ±0.05
HK 1005 33N∏-T	RoHS	33	±5%	8	100	11	16	20	23	22	1300	1900	0.80	0.50	200	250	0.50 ±0.05
HK 1005 39N∏-T	RoHS	39	±5%	8	100	11	16	20	23	21	1200	1700	0.90	0.52	200	250	0.50 ±0.05
HK 1005 47N□-T	RoHS	47	±5%	8	100	11	16	19	21	18	1000	1500	1.00	0.58	200	230	0.50 ±0.05
HK 1005 56N□-T	RoHS	56	±5%	8	100	11	16	18	18	16	750	1300	1.00	0.61	200	220	0.50 ±0.05
HK 1005 68N∏-T	RoHS	68	±5%	8	100	11	15	17	18	-11	750	1200	1.20	0.70	180	200	0.50 ±0.05
HK 1005 82N∏-T	RoHS	82	±5%	8	100	10	14	16	15	6	600	1100	1.30	0.81	150	200	0.50 ±0.05
HK 1005 R10∏-T	RoHS	100	±5%	8	100	10	14	14	12	-	600	1000	1.50	0.94	150	200	0.50 ±0.05
HK 1005 R12∏-T	RoHS	120	±5%	8	100	10	12	10	_	-	600	800	1.60	1.10	150	200	0.50 ±0.05
HK 1005 R15∏-T	RoHS	150	±5%	8	100	12	17	17	_	_	550	920	3.20	2.57	140	200	0.50 ±0.05
HK 1005 R18∏-T	RoHS	180	±5%	8	100	12	16	_	_	-	500	810	3.70	2.97	130	200	0.50 ±0.05
HK 1005 R22∏-T	RoHS	220	±5%	8	100	12	16	_	_	-	450	700	4.20	3.29	120	200	0.50 ±0.05
HK 1005 R27∏-T	RoHS	270	±5%	8	100	12	14	_	_	_	400	600	4.80	3.92	110	200	0.50 ±0.05

HK 1005 R27□−T RoHS 270 ±5% 8 100 12 14 − − − 400 600 4.80 3.92 110 200 0.50 ±0.05 Ж □ mark indicates the Inductance tolerance code. Please refer for the inductance tolerance except the above.

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HK 1608

HK 1608																
Parts number	EHS	Nominal inductance	Inductance tolerance ※)	Q (min.)	LQ Measuring frequency					[MHz]	frequen	resonant cy [MHz]	DC Res	sistance Ω]	Rated current	Thickness
		[nH]		([MHz]	100	300	500	800	1000	(min.)	(typ.)	(max.)	(typ.)		E
HK 1608 1N0[]-T	RoHS	1.0	±0.3nH	8	100	14	30	40	70	90	10000	> 13000	0.05	0.015	300	0.80 ±0.15
HK 1608 1N2[]-T	RoHS	1.2	±0.3nH	8	100	14	30	40	70	90	10000	> 13000	0.05	0.015	300	0.80 ±0.15
HK 1608 1N5[]-T	RoHS	1.5	±0.3nH	8	100	14	26	34	47	50	6000	> 13000	0.10	0.03	300	0.80 ±0.15
HK 1608 1N8∏-T	RoHS	1.8	±0.3nH	8	100	10	18	24	30	34	6000	> 13000	0.10	0.06	300	0.80 ±0.15
HK 1608 2N2[]-T	RoHS	2.2	±0.3nH	8	100	12	22	29	37	40	6000	12000	0.10	0.06	300	0.80 ±0.15
HK 1608 2N7∏-T	RoHS	2.7	±0.3nH	10	100	13	24	32	41	45	6000	11000	0.10	0.06	300	0.80 ±0.15
HK 1608 3N3∏-T	RoHS	3.3	±0.3nH	10	100	14	25	33	42	47	6000	9000	0.12	0.06	300	0.80 ±0.15
HK 1608 3N9∏-T	RoHS	3.9	±0.3nH	10	100	13	25	33	42	46	6000	8000	0.14	0.07	300	0.80 ±0.15
HK 1608 4N7∏-T	RoHS	4.7	±0.3nH	10	100	13	25	33	42	47	4000	6500	0.16	0.08	300	0.80 ±0.15
HK 1608 5N6∏-T	RoHS	5.6	±0.3nH	10	100	14	25	33	42	46	4000	5800	0.18	0.09	300	0.80 ±0.15
HK 1608 6N8∏-T	RoHS	6.8	±5%	10	100	14	25	33	43	47	4000	5600	0.22	0.11	300	0.80 ±0.15
HK 1608 8N2[]-T	RoHS	8.2	±5%	10	100	14	26	34	44	48	3500	5200	0.24	0.13	300	0.80 ±0.15
HK 1608 10N∏-T	RoHS	10	±5%	12	100	14	26	34	43	47	3400	4600	0.26	0.16	300	0.80 ±0.15
HK 1608 12N∏-T	RoHS	12	±5%	12	100	14	27	35	45	49	2600	4000	0.28	0.17	300	0.80 ±0.15
HK 1608 15N∏-T	RoHS	15	±5%	12	100	15	28	37	46	51	2300	3400	0.32	0.20	300	0.80 ±0.15
HK 1608 18N∏-T	RoHS	18	±5%	12	100	15	27	36	44	48	2000	3000	0.35	0.21	300	0.80 ±0.15
HK 1608 22N∏-T	RoHS	22	±5%	12	100	16	28	36	44	47	1600	2900	0.40	0.25	300	0.80 ±0.15
HK 1608 27N∏-T	RoHS	27	±5%	12	100	16	29	37	45	46	1400	2200	0.45	0.28	300	0.80 ±0.15
HK 1608 33N∏-T	RoHS	33	±5%	12	100	17	31	40	46	47	1200	1800	0.55	0.35	300	0.80 ±0.15
HK 1608 39N□-T	RoHS	39	±5%	12	100	18	31	39	44	44	1100	1600	0.60	0.38	300	0.80 ±0.15
HK 1608 47N∏-T	RoHS	47	±5%	12	100	17	28	34	35	34	900	1600	0.70	0.45	300	0.80 ±0.15
HK 1608 56N□-T	RoHS	56	±5%	12	100	17	28	34	34	31	900	1400	0.75	0.50	300	0.80 ±0.15
HK 1608 68N∏-T	RoHS	68	±5%	12	100	18	29	34	30	22	700	1200	0.85	0.55	300	0.80 ±0.15
HK 1608 82N∏-T	RoHS	82	±5%	12	100	18	28	33	27	-	600	1100	0.95	0.60	300	0.80 ± 0.15
HK 1608 R10□-T	RoHS	100	±5%	12	100	18	27	28	16	-	600	1000	1.00	0.65	300	0.80 ±0.15
HK 1608 R12□-T	RoHS	120	±5%	8	50	16	24	23	-	_	500	800	1.20	0.68	300	0.80 ± 0.15
HK 1608 R15∏-T	RoHS	150	±5%	8	50	13	19	16	_	-	500	800	1.20	0.73	300	0.80 ±0.15
HK 1608 R18∏-T	RoHS	180	±5%	8	50	13	18	12	_	-	400	700	1.30	0.85	300	0.80 ±0.15
HK 1608 R22∏-T	RoHS	220	±5%	8	50	12	16	_	_	_	400	600	1.50	0.95	300	0.80 ±0.15
HK 1608 R27□-T	RoHS	270	±5%	8	50	14	15	_	_	_	400	550	1.90	1.34	150	0.80 ±0.15
HK 1608 R33∏-T	RoHS	330	±5%	8	50	14	_	-	_	-	350	480	2.10	1.53	150	0.80 ±0.15
HK 1608 R39∏-T	RoHS	390	±5%	8	50	13	_	-	_	_	350	410	2.30	1.72	150	0.80 ±0.15
HK 1608 R47∏-T	RoHS	470	±5%	8	50	13	_	_	_	_	300	360	2.60	2.04	150	0.80 ±0.15

HK 2125

Parts number	EHS	Nominal inductance [nH]	Inductance tolerance	Q (min.)	LQ Measuring frequency [MHz]					[MHz]	frequen	resonant cy [MHz]	DC Res	5]	Rated current [mA] (max.)	Thickness [mm]
LIK OLOF LNEO. T	RoHS		10011	10		100	300	500 57	800 61	1000	(min.) 4000	(typ.) > 6000	(max.) 0.10	(typ.)	300	0.05 1.00
HK 2125 1N5S-T	RoHS	1.5	±0.3nH	10	100	18	35	49	55	59	4000	> 6000	0.10	0.02	300	0.85 ±0.2 0.85 ±0.2
HK 2125 1N8S-T			±0.3nH		100											
HK 2125 2N2S-T	RoHS	2.2	±0.3nH	10	100	18	33	46	53	58	4000	> 6000	0.10	0.03	300 300	0.85 ±0.2
HK 2125 2N7S-T	RoHS	2.7	±0.3nH	12	100	19	36	50	56	60	4000	> 6000	0.10	0.03		0.85 ±0.2
HK 2125 3N3S-T	RoHS	3.3	±0.3nH	12	100	16	29	40	47	51	4000	> 6000	0.13	0.04	300	0.85 ±0.2
HK 2125 3N9S-T	RoHS	3.9	±0.3nH	12	100	18	33	46	54	60	4000	> 6000	0.15	0.05	300	0.85 ±0.2
HK 2125 4N7S-T	RoHS	4.7	±0.3nH	12	100	18	34	46	55	60	3500	> 6000	0.20	0.05	300	0.85 ± 0.2
HK 2125 5N6S-T	RoHS	5.6	±0.3nH	15	100	20	38	51	60	66	3200	5400	0.23	0.05	300	0.85 ± 0.2
HK 2125 6N8J-T	RoHS	6.8	±5%	15	100	20	39	52	63	69	2800	4200	0.25	0.06	300	0.85 ± 0.2
HK 2125 8N2J-T	RoHS	8.2	±5%	15	100	21	40	54	63	70	2400	3700	0.28	0.07	300	0.85 ± 0.2
HK 2125 10NJ-T	RoHS	10	±5%	15	100	20	38	51	60	67	2100	3100	0.30	0.09	300	0.85 ± 0.2
HK 2125 12NJ-T	RoHS	12	±5%	15	100	21	39	52	60	67	1900	3000	0.35	0.10	300	0.85 ± 0.2
HK 2125 15NJ-T	RoHS	15	±5%	15	100	22	42	55	63	72	1600	2600	0.40	0.11	300	0.85 ± 0.2
HK 2125 18NJ-T	RoHS	18	±5%	15	100	24	44	57	63	72	1500	2300	0.45	0.13	300	0.85 ± 0.2
HK 2125 22NJ-T	RoHS	22	±5%	18	100	23	43	55	60	69	1400	2100	0.50	0.16	300	0.85 ± 0.2
HK 2125 27NJ-T	RoHS	27	±5%	18	100	23	42	53	58	68	1300	1800	0.55	0.17	300	0.85 ±0.2
HK 2125 33NJ-T	RoHS	33	±5%	18	100	24	43	54	55	60	1200	1700	0.60	0.19	300	0.85 ±0.2
HK 2125 39NJ-T	RoHS	39	±5%	18	100	23	41	50	47	47	1000	1400	0.65	0.25	300	0.85 ± 0.2
HK 2125 47NJ-T	RoHS	47	±5%	18	100	23	41	49	43	41	900	1200	0.70	0.26	300	1.00 +0.2/-0.3
HK 2125 56NJ-T	RoHS	56	±5%	18	100	23	42	48	39	38	800	1100	0.75	0.28	300	1.00 +0.2/-0.3
HK 2125 68NJ-T	RoHS	68	±5%	18	100	25	42	45	30	_	700	900	0.80	0.33	300	1.00 +0.2/-0.3
HK 2125 82NJ-T	RoHS	82	±5%	18	100	24	41	41	_	_	600	800	0.90	0.37	300	1.00 +0.2/-0.3
HK 2125 R10J-T	RoHS	100	±5%	18	100	23	37	37	-	-	600	800	0.90	0.40	300	1.00 +0.2/-0.3
HK 2125 R12J-T	RoHS	120	±5%	13	50	22	33	29	-	-	500	700	0.95	0.43	300	1.00 +0.2/-0.3
HK 2125 R15J-T	RoHS	150	±5%	13	50	22	34	26	-	-	500	700	1.00	0.46	300	1.00 +0.2/-0.3
HK 2125 R18J-T	RoHS	180	±5%	13	50	23	34	20	-	-	400	600	1.10	0.50	300	1.00 +0.2/-0.3
HK 2125 R22J-T	RoHS	220	±5%	12	50	20	23	_	_	_	350	550	1.20	0.75	300	1.00 +0.2/-0.3
HK 2125 R27J-T	RoHS	270	±5%	12	50	20	29	_	_	_	300	480	1.30	0.85	300	1.00 +0.2/-0.3
HK 2125 R33J-T	RoHS	330	±5%	12	50	22	15	_	_	_	250	400	1.40	0.90	300	1.00 +0.2/-0.3
HK 2125 R39J-T	RoHS	390	±5%	10	50	17	12	_	_	_	250	400	1.30	0.85	300	1.00 +0.2/-0.3
HK 2125 R47J-T	RoHS	470	±5%	10	50	17	_	_	_	_	200	350	1.50	0.95	300	1.00 +0.2/-0.3

^{※ ☐} mark indicates the Inductance tolerance code. Please refer for the inductance tolerance except the above.

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Multilayer chip inductors Multilayer chip inductors for high frequency, Multilayer chip bead inductors Multilayer common mode choke coils (MC series F type) Metal Multilayer Chip Power Inductors (MCOILTM MC series)

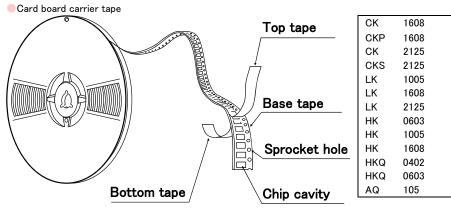
PACKAGING

1 Minimum Quantity

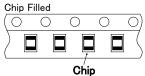
Tape & Reel Packaging	5		
Type	Thickness	Standard Q	uantity [pcs]
Турс	mm(inch)	Paper Tape	Embossed Tape
CK1608(0603)	0.8 (0.031)	4000	_
CK2125 (0805)	0.85(0.033)	4000	_
	1.25(0.049)	_	2000
CKS2125(0805)	0.85(0.033)	4000	_
	1.25(0.049)	_	2000
CKP1608 (0603)	0.8 (0.031)	4000	_
CKP2012 (0805)	0.9 (0.035)	_	3000
CKP2016 (0806)	0.9 (0.035)	_	3000
	0.7 (0.028)	_	3000
CKP2520 (1008)	0.9 (0.035)	_	3000
·	1.1 (0.043)	_	2000
NM2012 (0805)	0.9 (0.035)	_	3000
NM2520(1008)	0.9 (0.035)	_	3000
	1.1 (0.043)	_	2000
LK1005(0402)	0.5 (0.020)	10000	_
LK1608(0603)	0.8 (0.031)	4000	_
LK2125(0805)	0.85(0.033)	4000	_
	1.25(0.049)	_	2000
HK0603(0201)	0.3 (0.012)	15000	_
HK1005(0402)	0.5 (0.020)	10000	_
HK1608 (0603)	0.8 (0.031)	4000	_
HK2125(0805)	0.85(0.033)	_	4000
	1.0 (0.039)	_	3000
HKQ0402(01005)	0.2 (0.008)	20000	40000
HKQ0603W(0201)	0.3 (0.012)	15000	_
HKQ0603C(0201)	0.3 (0.012)	15000	_
HKQ0603S(0201)	0.3 (0.012)	15000	_
HKQ0603U(0201)	0.3 (0.012)	15000	_
AQ105(0402)	0.5 (0.020)	10000	_
BK0402(01005)	0.2 (0.008)	20000	_
BK0603(0201)	0.3 (0.012)	15000	_
BK1005(0402)	0.5 (0.020)	10000	_
BKH0603(0201)	0.3 (0.012)	15000	_
BKH1005(0402)	0.5 (0.020)	10000	_
BK1608(0603)	0.8 (0.031)	4000	_
BK2125(0805)	0.85 (0.033)	4000	_
DIV2123 (0003)	1.25(0.049)	_	2000
BK2010(0804)	0.45(0.018)	4000	_
BK3216(1206)	0.8 (0.031)	_	4000
BKP0402 (01005)	0.2 (0.008)	20000	_
BKP0603 (0201)	0.3 (0.012)	15000	_
BKP1005 (0402)	0.5 (0.020)	10000	_
BKP1608 (0603)	0.8 (0.031)	4000	_
BKP2125(0805)	0.85 (0.033)	4000	_
MCF0605(0202)	0.3 (0.012)	15000	_
MCF0806 (0302)	0.4 (0.016)	_	10000
MCF1210(0504)	0.55(0.022)	_	5000
MCF2010(0804)	0.45(0.018)	_	4000
MCFK1608(0603)	0.6 (0.024)	4000	_
MCFE1608(0603)	0.65 (0.026)	4000	_
MCHK2012(0806)	0.8 (0.031)	4000	_
MCKK2012(0805)	1.0 (0.039)	-	3000

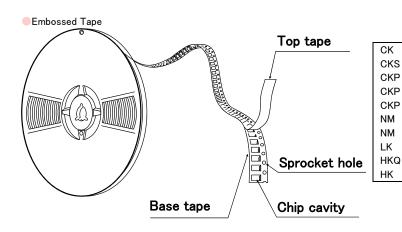
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Taping material

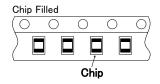


BK	0402
BK	0603
BK	1005
BK	1608
BK	2125
BK	2010
BKP	0402
BKP	0603
BKP	1005
BKP	1608
BKP	2125
BKH	0603
BKH	1005
MCF	0605
MC	1608
MC	2012

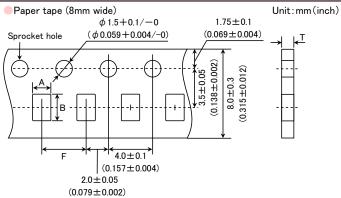




2125
3216
0806
1210
2010
2012



Taping Dimensions

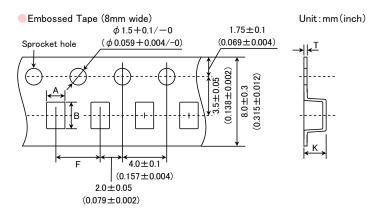


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_	Thickness	Chip	cavity	Insertion Pitch	Tape Thickness
Туре	mm(inch)	А	В	F	Т
CK1608(0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
OK1000 (0000)	0.0 (0.001)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
CK2125(0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
		(0.059±0.008)	(0.091 ± 0.008)	(0.157±0.004)	(0.043max)
CKS2125(0805)	0.85 (0.033)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.1max (0.043max)
		1.0±0.2	1.8±0.2	4.0±0.1	1.1max
CKP1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
	(2.222)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
LK1005(0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
LK1608 (0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
LK1006(0003)	0.6 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157±0.004)	(0.043max)
LK2125(0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
ERE120 (0000)	0.00 (0.000)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
HK0603(0201)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
		(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
HK1005(0402)	0.5 (0.020)	0.65 ± 0.1	1.15±0.1	2.0±0.05	0.8max (0.031max)
		(0.026±0.004) 1.0±0.2	(0.045±0.004) 1.8±0.2	(0.079±0.002) 4.0±0.1	(0.031max) 1.1max
HK1608(0603)	0.8 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.004)	(0.043max)
		0.25±0.04	0.45±0.04	2.0±0.05	0.36max
HKQ0402(01005)	0.2 (0.008)	(0.010 ± 0.002)	(0.018 ± 0.002)	(0.079 ± 0.002)	(0.014max)
LU(0.0000::/(0.0)	0.0 (2.7.1.)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603W(0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
LIKO06020 (0201)	0.2 (0.010)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
HKQ0603C(0201)	0.3 (0.012)	(0.016 ± 0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
HKQ0603S(0201)	0.3 (0.012)	0.40 ± 0.06	0.70±0.06	2.0±0.05	0.45max
111(400000 (0201)	0.0 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
HKQ0603U(0201)	0.3 (0.012)	0.40±0.06	0.70±0.06	2.0±0.05	0.45max
		(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
AQ105(0402)	0.5 (0.020)	0.75±0.1	1.15±0.1	2.0±0.05	0.8max
		(0.030 ± 0.004) 0.25 ± 0.04	(0.045±0.004) 0.45±0.04	(0.079±0.002) 2.0±0.05	(0.031max) 0.36max
BK0402(01005)	0.2 (0.008)	(0.010±0.002)	(0.018±0.002)	(0.079 ± 0.002)	(0.014max)
		0.40±0.06	0.70±0.06	2.0±0.05	0.45max
BK0603(0201)	0.3 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
DI(1005(0400)	2.5 (2.222)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
BK1005(0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
BK1608(0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
BK1008(0003)	0.6 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157±0.004)	(0.043max)
BK2125(0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
2.12.120 (0000)		(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157 ± 0.004)	(0.043max)
BK2010(0804)	0.45(0.018)	1.2±0.1	2.17±0.1	4.0±0.1	0.8max
		(0.047±0.004)	(0.085 ± 0.004)	(0.157±0.004)	(0.031max)
BKP0402 (01005)	0.2 (0.008)	0.25±0.04 (0.010±0.002)	0.45±0.04 (0.018±0.002)	2.0±0.05 (0.079±0.002)	0.36max (0.014max)
		0.40±0.06	0.70±0.06	2.0±0.05	0.45max
BKP0603 (0201)	0.3 (0.012)	(0.016±0.002)	(0.028 ± 0.002)	(0.079 ± 0.002)	(0.018max)
DIVD1005 (0100)	0.5 (0.000)	0.65±0.1	1.15±0.1	2.0±0.05	0.8max
BKP1005 (0402)	0.5 (0.020)	(0.026 ± 0.004)	(0.045 ± 0.004)	(0.079 ± 0.002)	(0.031max)
BKP1608 (0603)	0.8 (0.031)	1.0±0.2	1.8±0.2	4.0±0.1	1.1max
DIVE 1000 (0009)	0.0 (0.031)	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157±0.004)	(0.043max)
BKP2125 (0805)	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.1max
		(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157±0.004)	(0.043max)
BKH0603(0201)	0.3 (0.012)	0.40 ± 0.06	0.70 ± 0.06	2.0±0.05	0.45max
		(0.016±0.002)	(0.028±0.002)	(0.079±0.002)	(0.018max)
BKH1005(0402)	0.5 (0.020)	0.65±0.1 (0.026±0.004)	1.15±0.1 (0.045±0.004)	2.0±0.05 (0.079±0.002)	0.8max (0.031max)
		0.62±0.004)	0.77±0.03	2.0±0.05	0.45max
MCF0605 (0202)	0.3 (0.012)	(0.02±0.03 (0.024±0.001)	(0.030 ± 0.001)	(0.079 ± 0.002)	(0.018max)
		1.1±0.05	1.9±0.05	4.0±0.1	0.72max
	/ :				
MCFK1608 (0603)	0.6 (0.024)	(0.043 ± 0.002)	(0.075 ± 0.002)	(0.157 ± 0.004)	(0.028max)
	· · ·		(0.075±0.002) 1.9±0.05	(0.157±0.004) 4.0±0.1	(0.028max) 0.9max
MCFK1608 (0603) MCFE1608 (0603)	0.6 (0.024) 0.65 (0.026)	(0.043±0.002)			
	· · ·	(0.043±0.002) 1.1±0.05	1.9±0.05	4.0±0.1	0.9max

Unit : mm(inch)

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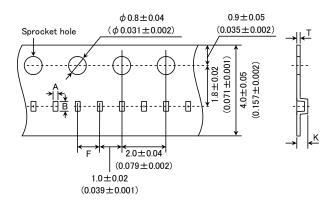
Type Thickness mm(inch)		Chip	cavity	Insertion Pitch	Tape Ti	nickness
		Α	В	F	K	Т
CK2125(0805)	1.25 (0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKS2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
CKP2012 (0805)	0.9 (0.035)	1.55 ± 0.2 (0.061 \pm 0.008)	2.3 ± 0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
CKP2016 (0806)	0.9 (0.035)	1.8±0.1 (0.071±0.004)	2.2±0.1 (0.087±0.004)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.01)
	0.7 (0.028)				1.4 (0.055)	
CKP2520 (1008)	0.9 (0.035)	2.3±0.1 (0.091±0.004)	2.8±0.1 (0.110±0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
	1.1 (0.043)				1.7 (0.067)	
NM2012 (0805)	0.9 (0.035)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.3 (0.012)
NM2520(1008)	0.9 (0.035)	2.3±0.1	2.8±0.1	4.0±0.1	1.4 (0.055)	0.3
	1.1 (0.043)	(0.091 ± 0.004)	(0.110±0.004)	(0.157±0.004)	1.7 (0.067)	(0.012)
LK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
	0.85(0.033)	1.5±0.2	2.3±0.2	4.0±0.1	1.5 (0.059)	0.3
HK2125(0805)	1.0 (0.039)	(0.059 ± 0.008)	(0.091 ± 0.008)	(0.157±0.004)	2.0 (0.079)	(0.012)
BK2125(0805)	1.25(0.049)	1.5±0.2 (0.059±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	2.0 (0.079)	0.3 (0.012)
BK3216(1206)	0.8(0.031)	1.9±0.1 (0.075±0.004)	3.5 ± 0.1 (0.138 ± 0.004)	4.0±0.1 (0.157±0.004)	1.4 (0.055)	0.3 (0.012)
MCF0806(0302)	0.4 (0.016)	0.75±0.05 (0.030±0.002)	0.95 ± 0.05 (0.037 \pm 0.002)	2.0±0.05 (0.079±0.002)	0.55 (0.022)	0.3 (0.012)
MCF1210(0504)	0.55(0.022)	1.15±0.05 (0.045±0.002)	1.40 ± 0.05 (0.055 \pm 0.002)	4.0±0.1 (0.157±0.004)	0.65 (0.026)	0.3 (0.012)
MCF2010(0804)	0.45(0.018)	1.1±0.1 (0.043±0.004)	2.3±0.1 (0.091±0.004)	4.0±0.1 (0.157±0.004)	0.85	0.3 (0.012)
MCKK2012 (0805)	1.0 (0.039)	1.55±0.2 (0.061±0.008)	2.3±0.2 (0.091±0.008)	4.0±0.1 (0.157±0.004)	1.3 (0.051)	0.25 (0.010)

Unit: mm(inch)

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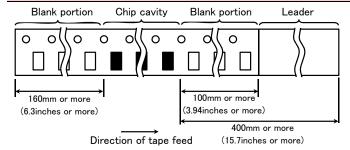
Embossed Tape (4mm wide)

Unit:mm(inch)

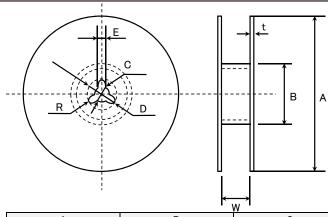


T	Thickness	Chip	cavity	Insertion Pitch	Tape Th	nickness
Туре	mm(inch)	Α	В	F	K	Т
HKQ0402 (01005)	0.2 (0.008)	0.23	0.43	1.0±0.02	0.5max.	0.25max.
					Unit	: mm

4LEADER AND BLANK PORTION



5Reel Size



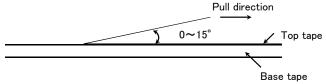
Α	B C		D	E	R
ϕ 178 ± 2.0	ϕ 50 or more	ϕ 13.0 \pm 0.2	ϕ 21.0±0.8	2.0±0.5	1.0

	t	W
4mm width tape	1.5max.	5±1.0
8mm width tape	2.5max.	10±1.5

(Unit : mm)

6Top tape strength

The top tape requires a peel-off force of $0.1 \sim 0.7 N$ in the direction of the arrow as illustrated below.



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Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOIL™ MC series)

■RELIABILITY DATA

1. Operating Tempe				
	BK0402			
	BK0603			
	BK1005			
	BKH0603			
	BKH1005			
	BK1608			
	BK2125			
	ARRAY	BK2010		
		BK3216		
	BKP0402			
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0605			
	MCF 0806		-40∼+85°C	
	MCF 1210			
	MCF 2010			
_	CK1608			
	CK2125			
Specified Value	CKS2125			
opecineu value	CKP1608			
	CKP2012			
	CKP2016		-40 s · + 95°C	
	CKP2520		-40~+85°C	
	NM2012			
	NM2520			
	LK1005			
	LK1608			
	LK2125		7	
	HKQ0402			
	HK0603		-55~+125°C	
	HK1005		7	
	HK1608		—————————————————————————————————————	
	HK2125		-40.4 ± 63 C	
	HKQ0603W/HK0	Q0603C/HKQ0603S/		
	HKQ0603U/		-55~+125°C	
	AQ105			
	MCFK1608			
	MCFE1608			
	MCHK2012		-40∼+125°C (Including self-generated heat)	
	MCKK2012			

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2. Storage Tempera				
	BK0402			
	BK0603			
	BK1005			
	BKH0603			
	BKH1005			
	BK1608			
	BK2125			
	ARRAY	BK2010		
	70000	BK3216		
	BKP0402			
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125			
	MCF 0605			
	MCF 0806		-40∼+85°C	
	MCF 1210		40 * 1 03 C	
	MCF 2010			
	CK1608			
	CK2125			
Specified Value	CKS2125			
Specified value	CKP1608			
	CKP2012			
	CKP2016		-40∼+85°C	
	CKP2520		-40 ⁻² +00 C	
	NM2012			
	NM2520			
	LK1005			
	LK1608			
	LK2125			
	HKQ0402			
	HK0603		-55~+125°C	
	HK1005			
	HK1608			
	HK2125		-40~+85 C	
	HKQ0603W/HK	(Q0603C/HKQ0603S/		
	HKQ0603U/			
	AQ105			
	MCFK1608			
	MCFE1608			
	MCHK2012		-40~+85°C	
	MCKK2012			

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3. Rated Current			
	BK0402		150~750mA DC
	BK0603		100∼500mA DC
	BK1005		120~1000mA DC
	BKH0603		115~450mA DC
	BKH1005		200~300mA DC
	BK1608		150~1500mA DC
	BK2125		200~1200mA DC
	ADDAY	BK2010	100mA DC
	ARRAY	BK3216	100∼200mA DC
	BKP0402	•	0.55~1.1A DC
	BKP0603		0.8~1.8A DC
	BKP1005		0.8~2.4A DC
	BKP1608		1.0~3.0A DC
	BKP2125		1.5~4.0A DC
	MCF 0605		0.05A DC
	MCF 0806		0.1~0.13A DC
	MCF 1210		0.1~0.15A DC
	MCF 2010		0.1A DC
	CK1608		50∼60mA DC
	CK2125		60~500mA DC
	CKS2125		110~280mA DC
	CKP1608		0.35~0.9A DC
Specified Value	CKP2012		0.7∼1.7A DC
	CKP2016		0.9∼1.6A DC
	CKP2520		1.1~1.8A DC
	NM2012		1.0~1.2A DC
	NM2520		0.9~1.2A DC
	LK1005		20~25mA DC
	LK1608		1~150mA DC
	LK2125		5~300mA DC
	HK0603		60~470mA DC
	HK1005		110~300mA DC (-55~+125°C) 200~900mA DC (-55~+85°C)
	HK1608		150~300mA DC
	HK2125		300mA DC
	HKQ0402		100~500mA DC
	HKQ0603W		100∼850mA DC
	HKQ0603C		160~850mA DC
	HKQ0603S		130~600mA DC
	HKQ0603U		190~900mA DC
	AQ105		280~710mA DC
	MCFK1608		Idc1 : 1900~2300mA DC, Idc2 : 1600~2100mA DC

Definition of rated current:

MCFE1608

MCHK2012

MCKK2012

- •In the CK, CKS and BK Series, the rated current is the value of current at which the temperature of the element is increased within 20°C.
- In the BK Series P type, CK Series P type, NM Series, the rated current is the value of current at which the temperature of the element is increased within 40°C.

Idc1:

Idc1

•In the LK, HK, HKQ0603, and AQ Series, the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.

1400~2600mA DC,

3210~4320mA DC,

Idc2 : 800~1500mA DC

3240~3600mA DC

Idc2

Idc1: 4500~6200mA DC, Idc2: 3100~4000mA DC

- •In the HKQ0402(~9N1), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 20°C.
- •In the HKQ0402(10N~), the rated current is either the DC value at which the initial L value is decreased within 5% with the application of DC bias, or the value of current at which the temperature of the element is increased within 25°C.
- •In the MC Series, Idc1 is the DC value at which the initial L value is decreased within 30% and Idc2 is the DC value at which the temperature of element is increased within 40°C by the application of DC bias. (at 20°C)

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$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
$\begin{array}{c ccccccccccccccccccccccccccccccccccc$	
ARRAY BK3216 $60 \sim 1000 \Omega \pm 25\%$ BKP0402 $10 \sim 33 \Omega \pm 5 \Omega (10 \Omega), \pm 25\% (Other)$ BKP0603 $10 \sim 120 \Omega \pm 5 \Omega (10 \Omega), \pm 25\% (Other)$ BKP1005 $10 \sim 330 \Omega \pm 5 \Omega (EM100), \pm 25\% (Other)$ BKP1608 $33 \sim 470 \Omega \pm 25\%$	
BKP0402 $10 \sim 33 \Omega \pm 5 \Omega (10 \Omega, \pm 25\% (Other))$ BKP0603 $10 \sim 120 \Omega \pm 5 \Omega (10 \Omega, \pm 25\% (Other))$ BKP1005 $10 \sim 330 \Omega \pm 5 \Omega (EM100), \pm 25\% (Other)$ BKP1608 $33 \sim 470 \Omega \pm 25\%$	
BKP1005 $10 \sim 120 \Omega \pm 5 \Omega (10 \Omega)$, $\pm 25\% (Other)$ BKP1608 $10 \sim 330 \Omega \pm 5 \Omega (EM100)$, $\pm 25\% (Other)$ 33 ~ 470 Ω ± 25%	
BKP1005 $10\sim330\Omega\pm 5\Omega$ (EM100), ±25 %(Other) BKP1608 $33\sim470\Omega\pm25$ %	
BKP1608 $33\sim470\Omega\pm25\%$	
\mid BKP2125 \mid 33 \sim 330 Ω \pm 25%	
MCF 0605 $12 \sim 90 \Omega \pm 5 \Omega (12 \Omega), \pm 20\% (35 \Omega), \pm 25\% (Other)$	
MCF 0806 $12 \sim 90 \Omega \pm 5 \Omega (12 \Omega), \pm 20\% (Other)$	
MCF 1210 $40 \sim 90 \Omega \pm 20\% (2H900), \pm 25\% (Other)$	
MCF 2010 90Ω ±25%	
CK1608	
CK2125	
CKS2125	
Specified Value CKP1608	
CKP1000 CKP2012	
CKP2012 CKP2016	
CKP2520	
NM2012	
NM2520	
LK1005	
LK1608	
LK2125	
HKQ0402 HK0603	
HK1005	
HK1608	
HK2125	
HKQ0603W/HKQ0603C/HKQ0603S/	
HKQ0603U	
AQ105	
MCFK1608 MCFE1608	
MCHK2012	
MCKK2012 BK0402Series, BKP0402Series	
Measuring frequency : 100±1MHz	
Measuring equipment : E4991A(or its equivalent)	
Measuring jig : 16197A(or its equivalent)	
BK0603Series, BKP0603Series	
Measuring frequency : 100±1MHz	
Measuring equipment : 4291A (or its equivalent)	
Measuring jig : 16193A(or its equivalent)	
BK1005Series. BKP1005Series. BKH1005Series	
Test Methods and Measuring frequency : 100±1MHz	
Remarks Measuring equipment : 4291A(or its equivalent)	
Measuring jig : 16192A(or its equivalent), 16193A(or its equivalent)	
BK1608 • 2125Series, BKP1608 • 2125Series	
Measuring frequency : 100±1MHz	
Measuring frequency : 100±1MHz Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)	
Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent)	
Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent) Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW	
Measuring equipment : 4291A(or its equivalent), 4195A(or its equivalent) Measuring jig : 16092A(or its equivalent) or 16192A(or its equivalent)/HW BK2010-3216Series, MCF Series	

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5 Industria			
5. Inductance	DK0403		
	BK0402		-
	BK0603		4
	BK1005		-
	BKH0603		-
	BKH1005 BK1608		-
			-
	BK2125 BK2010		-
	ARRAY BK3216		-
	BKP0402		-
	BKP0603		-
	BKP1005		
	BKP1608		
	BKP2125		
	MCF 0605		-
	MCF 0806		1
	MCF 1210		1
	MCF 2010		
	CK1608		4.7~10.0 µH: ±20%
	CK2125		0.1~10.0 µH: ±20%
	CKS2125		1.0~10.0 µH: ±20%
	CKP1608		0.33~2.2 µH: ±20%
Specified Value	CKP2012		0.47~4.7 µH: ±20%
Specified Value	CKP2016		0.47~4.7 µH: ±20%
	CKP2520		0.47~4.7 μH: ±20%
	NM2012		0.82∼1.0 µH: ±20%
	NM2520		1.0~2.2 µH: ±20%
	LK1005		0.12~2.2 μH: ±10 or 20%
	LK1608		0.047~33.0 µH: ±20% 0.10~12.0 µH: ±10%
	LK2125		0.047~33.0 µH: ±20% 0.10~12.0 µH: ±10%
	HK0603		1.0~6.2nH: ±0.3nH 6.8~100nH: ±5%
	HK1005		1.0~6.2nH: ±0.3nH 6.8~270nH: ±5%
	HK1608		1.0~5.6nH: ±0.3nH 6.8~470nH: ±5%
	HK2125		1.5∼5.6nH: ±0.3nH 6.8∼470nH: ±5%
	HKQ0402		0.5 \sim 3.9nH: \pm 0.1 or 0.2 or 0.3nH 4.3 \sim 5.6nH: \pm 0.3nH or 3% or 5%
	111(40102		6.2~47nH: ±3 or 5%
	HKQ0603W		0.6~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~6.2nH: ±0.2 or 0.3nH or 3 or 5%
			6.8~30nH: ±3 or 5% 33~100nH: ±5%
	HKQ0603C		0.6~3.9nH: ±0.1 or 0.2 or 0.3nH 4.3~6.2nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%
	HKQ0603S		0.6~6.2nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5%
	HKQ0603U		0.6~4.2nH: ±0.1 or 0.2 or 0.3nH 4.3~6.5nH: ±0.2 or 0.3nH 6.8~22nH: ±3 or 5% 1.0~6.2nH: ±0.3nH 6.8~15nH: ±5%
	AQ105		
	MCFK1608 MCFE1608		0.24~0.47H: ±20% 0.24~1.0 µH: ±20%
	MCHK2012		0.24~0.47H: ±20%
	MCKK2012		0.24~0.47H: ±20%
	CK, LK, CKP, NM, MC Series		V.E.1 V.1711. ±20//
	Measuring frequency	: 2~4MHz(CK16	608)
	Measuring frequency	: 2~25MHz(CK2	
	Measuring frequency	: 2~10MHz(CKS	
	Measuring frequency	: 10~25MHz(LK	(1005)
	Measuring frequency	: 1~50MHz(LK1	608)
	Measuring frequency	: 0.4~50MHz(Lh	
	Measuring frequency		8 • CKP2012 • CKP2016 • CKP2520 • NM2012 • NM2520 • MCFK1608 • MCFE1608 • MCHK2012 • MCKK2012)
	Measuring equipment /jig		B+16092A(or its equivalent) ·4195A+41951+16092A(or its equivalent)
			2A(or its equivalent) •4291A+16193A(or its equivalent)/LK1005
			H1A + 42842C + 42851 - 61100 (or its equivalent)/CKP1608 · CKP2012 · CKP2016 · CKP2520 · NM2012 · K1608 · MCEE1609 · MCHK2012 · MCKK2012
Test Methods and	Measuring ourrent	NM2520 • MCF :•1mA rms(0.047	K1608·MCFE1608·MCHK2012·MCKK2012
Remarks	Measuring current	•0.1mA rms(0.04)	
	HK, HKQ, AQ Series	0.1111A 11115 (J.C	υ ου μι,
	Measuring frequency	: 100MHz(HK060	03•HK1005•AQ105)
	Measuring frequency	: 50/100MHz(Hk	
	Measuring frequency		603C·HKQ0603S·HKQ0603U)
	Measuring frequency	: 300/500MHz(H	
	Measuring frequency	: 100/500MHz(H	
	Measuring equipment /jig	:•4291A+16197	A(or its equivalent)/HK0603•AQ105
			3A(or its equivalent)/HK1005
			97A(or its equivalent)/HKQ0603S•HKQ0603U•HKQ0603W•HKQ0603C
			2A + in-house made jig(or its equivalent)/HK1608•HK2125
		•E4991A+1619	96D(or its equivalent)/HKQ0402

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6.0			
6. Q	BK0402		
	BK0603		1
	BK1005		1
	BKH0603		1
	BKH1005		
	BK1608		1
	BK2125		1
	BK2010		1
	ARRAY BK3216		1
	BKP0402		 -
	BKP0603		1
	BKP1005		1
	BKP1608		1
	BKP2125		1
	MCF 0605		
	MCF 0806		
	MCF 1210		
	MCF 2010		
	CK1608		
	CK2125		
	CKS2125		
Specified Value	CKP1608		
•	CKP2012		_
	CKP2016		-
	CKP2520		-
	NM2012 NM2520		1
	LK1005		10~20 min.
	LK1608		10~20 min.
	LK2125		15~50 min.
	HK0603		4~5 min.
	HK1005		8 min.
	HK1608		8~12 min.
	HK2125		10~18 min.
	HKQ0402		3∼8 min.
	HKQ0603W		6∼15 min.
	HKQ0603C		14~15 min.
	HKQ0603S		10~13 min.
	HKQ0603U AQ105		14 min.
	MCFK1608		8 min.
	MCFK1608 MCFE1608		1
	MCHK2012		
	MCKK2012		1
	LK Series		I .
	Measuring frequency	: 10~25MHz(LK10	005)
	Measuring frequency	: 1~50MHz(LK160	
	Measuring frequency	: 0.4~50MHz(LK21	
	Measuring equipment /jig		+16092A(or its equivalent)
			-16092A(or its equivalent)
			(or its equivalent)
	Measuring current	•4291A + 16193A •1mA rms(0.047	(or its equivalent)/LK1005 ~4.7./H)
	Measuring current	•0.1mA rms(5.6~	
Test Methods and	HK、HKQ、AQ Series	2.1111/111113(0.0	y - y - y - y - y - y - y - y - y -
Remarks	Measuring frequency	: 100MHz(HK0603•	·HK1005·AQ105)
	Measuring frequency	: 50/100MHz(HK16	
	Measuring frequency		3C·HKQ0603S•HKQ0603U)
	Measuring frequency	: 300/500MHz(HKC	
	Measuring frequency	: 100/500MHz(HKC	
	Measuring equipment /jig		or its equivalent) /HK0603 · AQ105
			(or its equivalent) /HK1005 A (or its equivalent) /HKQ0603S∙HKQ0603U∙HKQ0603W∙HKQ0603C
			+ in-house made jig(or its equivalent)/HK1608, HK2125
			D(or its equivalent) HKQ0402
	ı		

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7. DC Resistance			
	BK0402		0.07∼1.2Ωmax.
	BK0603		0.065∼1.50 Ω max.
	BK1005		0.03~0.90 Ω max.
	BKH0603		0.26∼3.20 Ω max.
	BKH1005		0.85~2.00 Ω max.
	BK1608		0.05∼1.10Ω max.
	BK2125		0.05~0.75Ω max.
	4004)/	BK2010	0.10~0.90Ω max.
	ARRAY	BK3216	0.15~0.80 Ω max.
	BKP0402		0.05~0.15 Ω max.
	BKP0603		0.030~0.180Ω max.
	BKP1005		0.0273~0.220Ω max.
	BKP1608		0.025~0.18 Ω max.
	BKP2125		0.020~0.075Ω max.
	MCF 0605		2.5~6.5 Ω max
	MCF 0806		2.5∼5.0 Ω max.
	MCF 1210		2.5~4.5 Ω max.
	MCF 2010		4.5Ω max.
	CK1608		$0.45 \sim 0.85 \Omega(\pm 30\%)$
	CK2125		0.16~0.65 Ω max.
	CKS2125		0.12~0.52 Ω max.
	CKP1608		0.15~0.35Ω max.
Specified Value	CKP2012		0.08~0.28 Ω max.
	CKP2016		0.075~0.20 Ω max
	CKP2520		0.05~0.16 Ω max.
	NM2012		0.10~0.15Ω max.
	NM2520		0.11~0.22 Ω max.
	LK1005		0.41~1.16Ω max.
	LK1608		0.2~2.2Ω max.
	LK2125		0.1~1.1Ω max.
	HK0603		0.11~3.74Ω max.
	HK1005		0.08~4.8 Ω max.
	HK1608		0.05~2.6 Ω max.
	HK2125		0.10~1.5Ω max.
	HKQ0402		0.08~5.0Ω max.
	HKQ0603W		0.07~4.1 Ω max.
	HKQ0603W		0.07~1.6Ω max.
	HKQ0603S		0.06~1.29 Ω max.
	HKQ0603U		0.06~1.29 Ω max.
	AQ105 MCFK1608		0.07~0.45 Ω max. 0.050~0.085 Ω max.
	MCFE1608		0.100~0.340 Ω max.
	MCHK2012		0.024~0.036 Ω max.
	MCKK2012		0.025 ~0.039 Ω max.
Test Methods and Remarks	Measuring equipme	ent:VOAC-7412, VOA	AC-7512, VOAC-7521 (made by Iwasaki Tsushinki), HIOKI3227 (or its equivalent)

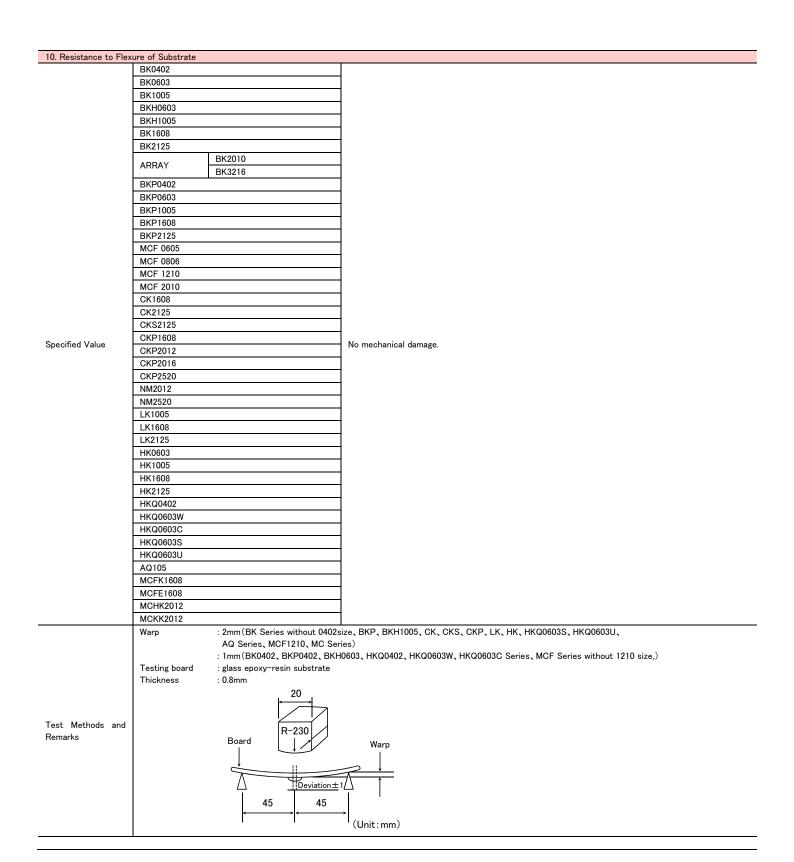
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	, <u> </u>			
8. Self Resonance Free	· · ·			
	BK0402			
	BK0603			
	BK1005			
	BKH0603			
	BKH1005			
	BK1608			
	BK2125			
	ARRAY	BK2010		
		BK3216	_ _	_
	BKP0402			
	BKP0603			
	BKP1005			
	BKP1608			
	BKP2125		_ _	
	MCF 0605			
	MCF 0806			
	MCF 1210			
	MCF 2010			
	CK1608			17~25MHz min.
	CK2125			24~235MHz min.
	CKS2125			24~75MHz min.
Specified Value	CKP1608			
Specifica Value	CKP2012			
	CKP2016			_
	CKP2520			
	NM2012			1
	NM2520			
	LK1005			40~180MHz min.
	LK1608			9~260MHz min.
	LK2125			13~320MHz min.
	HK0603			900~10000MHz min.
	HK1005			400~10000MHz min.
	HK1608			300~10000MHz min.
	HK2125			200~4000MHz min.
	HKQ0402			1200~10000MHz min.
	HKQ0603W			800~10000MHz min.
	HKQ0603C			2500~10000MHz min.
	HKQ0603S			1900~10000MHz min.
	HKQ0603U			1900~10000MHz min.
	AQ105			2300~10000MHz min.
	MCFK1608			1
	MCFE1608			-
	MCHK2012			-
	MCKK2012			
	LK, CK Series :		41054/ "	
Test Methods and	Measuring equip	oment	: 4195A (or its equiv	
Remarks	Measuring jig	vice :	: 41951+16092A(o	or its equivalent)
	HK, HKQ, AQ Se Measuring equip		· 87190 (or its	valent) •8753D(or its equivalent)/HK2125
	wieasuring equip	ment	. 07190 (or its equit	valent/ -0/000 (or its equivalent// IRZ120

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9. Temperature Chara							
	BK0402						
	BK0603						
	BK1005						
	BKH0603						
	BKH1005						
	BK1608						
	BK2125						
	ARRAY	BK2010					
		BK3216					
	BKP0402						
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605			_			
	MCF 0806						
	MCF 1210						
	MCF 2010						
	CK1608						
	CK2125						
	CKS2125						
Specified Value	CKP1608						
-	CKP2012						
	CKP2016						
	CKP2520						
	NM2012						
	NM2520						
	LK1005						
	LK1608						
	LK2125						
	HK0603						
	HK1005						
	HK1608						
	HK2125						
	HKQ0402						
	HKQ0603W						
	HKQ0603C			Inductance change:Within ±10%			
	HKQ0603S			andocanos change. Manin = 1070			
	HKQ0603U						
	AQ105						
	MCFK1608						
	MCFE1608						
	MCHK2012						
	MCKK2012						
	HK, HKQ, AQ Se						
	Temperature rar		: −30~+85°C				
Test Methods and	Reference temp	erature	: +20°C				
Remarks	MC Series:						
	Temperature rar	_	: −40~+85°C				
	Reference temp	erature	: +20°C				

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11. Solderability							
	BK0402						
	BK0603						
	BK1005		<u> </u>				
	BKH0603		<u> </u>				
	BKH1005						
	BK1608						
	BK2125	1					
	ARRAY	BK2010					
		BK3216					
	BKP0402						
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605						
	MCF 0806						
	MCF 1210						
	MCF 2010						
	CK1608						
	CK2125						
Specified Value	CKS2125						
	CKP1608		At least 75% of terminal electrode is covered by new solder.				
	CKP2012						
	CKP2016						
	CKP2520						
	NM2012]				
	NM2520						
	LK1005						
	LK1608						
	LK2125]				
	HK0603		1				
	HK1005]				
	HK1608		1				
	HK2125]				
	HKQ0402		1				
	HKQ0603W		1				
	HKQ0603C		1				
	HKQ0603S		1				
	HKQ0603U		1				
	AQ105		1				
	MCFK1608		1				
	MCFE1608		1				
	MCHK2012		1				
	MCKK2012		1				
T . M .:	Solder temperatu	re :230±5°C (JIS Z 32					
Test Methods and	Solder temperatu						
Remarks	Duration	:4±1 sec.					

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10 Decistant to 0.11	lavias.					
12. Resistance to Sold						
	BK0402					
	BK0603					
	BK1005					
	BKH0603					
	BKH1005					
	BK1608		1 N 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1			
	BK2125	_	Appearance: No significant abnormality			
	ARRAY BK201		Impedance change: Within ±30%			
	BK321	6				
	BKP0402					
	BKP0603					
	BKP1005					
	BKP1608					
	BKP2125					
	MCF 0605					
	MCF 0806		Appearance: No significant abnormality			
	MCF 1210		Impedance change: Within ±20%			
	MCF 2010					
	CK1608		No mechanical damage.			
	CK2125		Remaining terminal electrode: 70% min			
	CKS2125		1			
	CKP1608		Inductance change			
	CKP2012		R10~4R7: Within ±10% 6R8~100: Within ±15% CKS2125: Within ±20% CKP1608、CKP2012、CKP2016、CKP2520、NM2012、NM2520: Within ±30%			
Specified Value	CKP2016					
Specified value	CKP2520					
	NM2012					
	NM2520					
	LK1005		No mechanical damage.			
	LK1005		Remaining terminal electrode: 70% min.			
	LK1608		Inductance change: Within ±15% No mechanical damage.			
	LK1000		Remaining terminal electrode: 70% min.			
			Inductance change			
	LK2125		47N~4R7: Within ±10%			
			5R6~330: Within ±15%			
	HK0603					
	HK1005					
	HK1608		No mechanical damage.			
	HK2125					
	HKQ0402					
	HKQ0603W		Remaining terminal electrode: 70% min.			
	HKQ0603C		Inductance change: Within ±5%			
	HKQ0603S					
	HKQ0603U					
	AQ105					
	MCFK1608		N			
	MCFE1608		No mechanical damage.			
	MCHK2012		Remaining terminal electrode: 70% min.			
	MCKK2012		Inductance change: Within ±10%			
	Solder temperature	:260±5°C				
	Duration	$:10\pm0.5\;{\rm sec.}$				
Test Methods and	Preheating temperature	:150 to 180°C				
Remarks	Preheating time	:3 min.				
	Flux		methanol solution with colophony for 3 to 5 sec.			
	Recovery		covery under the standard condition after the test.(See Note 1)			
(Note 1) When there a	re questions concerning me	asurement result; measure	ement shall be made after 48±2 hrs of recovery under the standard condition.			

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13. Thermal Shock							
13. Thermal Shock	BK0402		1				
	BK0603		-				
	BK1005		-				
	BKH0603		-				
			-				
	BKH1005		4				
	BK1608		┪, ,, ,	200 - 1 - 12			
	BK2125	L DIVOCALO.		gnificant abnormality			
	ARRAY	BK2010	Impedance change	: Within ±30%			
	DI/D0400	BK3216	_				
	BKP0402		-				
	BKP0603		-				
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605						
	MCF 0806		- 1	gnificant abnormality			
	MCF 1210		Impedance change	: Within ±20%			
	MCF 2010						
	CK1608		No mechanical dan				
	CK2125			:Within ±20% Q change:Within ±30%			
	CKS2125		Inductance change	:Within ±20% (CKS2125)			
Specified Value	CKP1608						
Specified Value	CKP2012						
	CKP2016		No mechanical dan	nage.			
	CKP2520		Inductance change	: Within ±30%			
	NM2012						
	NM2520						
	LK1005		No mechanical damage. Inductance change: Within ±10% Q change: Within ±30%				
	LK1608						
	LK2125						
	HK0603						
	HK1005						
	HK1608						
	HK2125						
	HKQ0402		No mechanical damage.				
	HKQ0603W		Inductance change	Inductance change: Within ±10% Q change: Within ±20%			
	HKQ0603C						
	HKQ0603S						
	HKQ0603U						
	AQ105						
	MCFK1608						
	MCFE1608		Appearance: No sig	gnificant abnormality			
	MCHK2012		Inductance change	: Within ±10%			
	MCKK2012						
	Conditions for	1 cycle					
	Step	temperature (°C)		time (min.)			
	1	Minimum operating temperature	re +0/-3	30±3			
Test Methods and	2	Room temperature		2~3			
Remarks	3	Maximum operating temperatu	re $+3/-0$	30±3			
	4	Room temperature		2~3			
	Number of cycl	les:5					
	Recovery: 2 to	3 hrs of recovery under the standar	rd condition after the	test (See Note 1)			

Recovery: 2 to 3 hrs of recovery under the standard condition after the test. (See Note 1)

(Note 1) When there are questions concerning measurement result; measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

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14 Damm Hart C	du stata)					
14. Damp Heat (Stead	dy state) BK0402					
	BK0603					
	BK1005					
	BKH0603					
	BKH1005					
	BK1608					
	BK2125		Appearance: No significant abnormality			
	ARRAY	BK2010	Impedance change: Within ±30%			
	70000	BK3216				
	BKP0402					
	BKP0603					
	BKP1005					
	BKP1608					
	BKP2125					
	MCF 0605					
	MCF 0806		Appearance: No significant abnormality			
	MCF 1210		Impedance change: Within ±20%			
	MCF 2010		ampodunos shangs. Wallin =2575			
	CK1608		No mechanical damage.			
	CK1008		4			
			Inductance change: Within ±20% Q change: Within ±30%			
	CKS2125		Inductance change: Within ±20%			
	CKP1608					
Specified Value	CKP2012					
	CKP2016		No mechanical damage.			
	CKP2520		Inductance change: Within ±30%			
	NM2012					
	NM2520					
	LK1005		No mechanical damage.			
	LK1608		Inductance change: Within ±10% Q change: Within ±30%			
	11/0105		No mechanical damage.			
	LK2125		Inductance change: Within ±20% Q change: Within ±30%			
	HK0603					
	HK1005					
	HK1608					
	HK2125					
	HKQ0402		No mechanical damage.			
	HKQ0603W		Inductance change: Within ±10% Q change: Within ±20%			
	HKQ0603W		madetarioe charge. Walling 21070 & charge. Walling 22070			
	HKQ0603C					
	HKQ0603U					
	AQ105					
	MCFK1608					
	MCFE1608		Appearance: No significant abnormality			
	MCHK2012		Inductance change: Within ±10%			
	MCKK2012					
	BK, BKP, BKH S	eries, MCF Series:				
	Temperature	:40±2°C				
	Humidity	:90 to 95%RH				
	Duration	:500+24/-0 hrs				
	Recovery	:2 to 3 hrs of recovery under the	ne standard condition after the removal from test chamber.(See Note 1)			
Test Methods and						
Remarks	LK, CK, CKS, CH	KP、NM、HK、HKQ、AQ、MC Serie				
	Temperature	:40±2°C(LK, CK, CKS, CKP				
		:60±2°C(HK, HKQ, AQ, MC	Series)			
	Humidity	:90 to 95%RH				
	I D ::	. 500 ± 12 hun				
	Duration	:500±12 hrs				
	Recovery		ne standard condition after the removal from test chamber.(See Note 1)			

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15. Loading under Dar	mn Heat						
To. Loading under Dar	BK0402						
	BK0603		1				
	BK1005						
	BKH0603						
	BKH1005						
	BK11603						
	BK2125		Appearance: No significant abnormality				
	BK2010		Impedance change: Within ±30%				
	I ARRAY —	K3216	Impedance change. Within ±30%				
	BKP0402						
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	CK1608		No mechanical damage.				
	CK2125		Inductance change: Within ±20% Q change: Within ±30%				
	OKETEO		No mechanical damage.				
	CKS2125		Inductance change: Within ±20%				
	CKP1608		The state of the light in the l				
	CKP2012		1				
	CKP2016		No mechanical damage.				
	CKP2510		Inductance change: Within ±30%				
Specified Value	NM2012						
•	NM2520						
			No mechanical damage.				
	LK1005		Inductance change: Within ±10% Q change: Within ±30%				
			No mechanical damage.				
	LK1608		Inductance change: $0.047 \sim 12.0 \mu\text{H}$: Within $\pm 10\%$ $15.0 \sim 33.0 \mu\text{H}$: Within $\pm 15\%$				
			Q change: Within ±30%				
	LK2125		No mechanical damage.				
	LIVETES		Inductance change: Within ±20% Q change: Within ±30%				
	HK0603						
	HK1005						
	HK1608						
	HK2125						
	HKQ0402		No mechanical damage.				
	HKQ0603W		Inductance change: Within $\pm 10\%$ Q change: Within $\pm 20\%$				
	HKQ0603C						
	HKQ0603S						
	HKQ0603U		_				
	AQ105						
	MCFK1608※						
	MCFE1608※		Appearance: No significant abnormality				
	MCHK2012※		Inductance change: Within ±10%				
	MCKK2012※						
	BK, BKP, BKH Serie						
	Temperature	:40±2°C					
	Humidity Applied current	: 90 to 95%RH : Rated current					
	Duration	:500+24/-0 hrs					
	Recovery		der the standard condition after the removal from test chamber.(See Note 1)				
Test Methods and	-	NM, HK, HKQ, AQ, MC Serie					
Remarks	Temperature	:40±2°C(LK, CK, CKS,					
	· .	:60±2°C(HK, HKQ, AQ,					
	Humidity	:90 to 95%RH					
	Applied current	:Rated current ※MC seri	ies ; Idc2max				
	Duration	:500±12 hrs					
-	Recovery	:2 to 3 hrs of recovery und	der the standard condition after the removal from test chamber.(See Note 1)				

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to $35^{\circ}\!\text{C}\,$ of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20\pm2^{\circ}C$ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure.

Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48 ± 2 hrs of recovery under the standard condition.

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16 Looding at High T.	amparatura						
16. Loading at High Te	1						
	BK0402		4				
	BK0603						
	BK1005						
	BKH0603		4				
	BKH1005		4				
	BK1608		Annual No. 1 of the Street of the country of the				
	BK2125		Appearance: No significant abnormality				
	ARRAY	BK2010	Impedance change: Within ±30%				
	BK3216		-				
	BKP0402						
	BKP0603						
	BKP1005						
	BKP1608						
	BKP2125						
	MCF 0605						
	MCF 0806		Appearance: No significant abnormality				
	MCF 1210		Impedance change: Within ±20%				
	MCF 2010						
	CK1608		No mechanical damage.				
	CK2125		Inductance change: Within ±20% Q change: Within ±30%				
	CKS2125		No mechanical damage.				
			Inductance change: Within ±20%				
	CKP1608		-				
0 (0 1)/ 1	CKP2012						
Specified Value	CKP2016		No mechanical damage.				
	CKP2520		Inductance change: Within ±30%				
	NM2012						
	NM2520						
	LK1005		No mechanical damage.				
			Inductance change: Within ±10% Q change: Within ±30%				
			No mechanical damage.				
	LK1608		Inductance change: $0.047 \sim 12.0 \mu\text{H}$: Within $\pm 10\%$ $15.0 \sim 33.0 \mu\text{H}$: Within $\pm 15\%$				
			Q change: Within ±30%				
	LK2125		No mechanical damage.				
	HK0603		Inductance change: Within ±20% Q change: Within ±30%				
	HK1005						
	HK1608						
	HK2125						
	HKQ0402		No markonized demand				
	HKQ0603W		No mechanical damage.				
	HKQ0603W HKQ0603C		Inductance change: Within ±10% Q change: Within ±20%				
	HKQ0603S		-				
	HKQ0603U						
	AQ105						
	MCFK1608%		Annual No. 1 of the Street of the country of the				
	MCFE1608※		Appearance: No significant abnormality				
	MCHK2012※ MCKK2012※		Inductance change: Within ±10%				
	+	Porios MCE Savias					
	Temperature	eries、MCF Series: : 125±3°C(BK、BKH Series)					
	remperature	: 85±3°C(BKP, MCF Series)					
	Applied current	: Rated current					
	Duration	:500+24/-0 hrs					
	Recovery		he standard condition after the removal from test chamber.				
T . M		(See Note 1)					
Test Methods and	LK, CK, CKS, CH	KP, NM, HKQ, AQ, MC Series:					
Remarks	Temperature	:85±2°C(LK,CK,CKS,CKP,	NM、MC Series)				
		: 85±2°C(HK1608, 2125)					
			rating temperature range $-55 \sim +85^{\circ}$ C)				
		: 125±2°C (HKQ0402, HK0603,	HK1005, HKQ0603S, HKQ0603U, HKQ0603W, HKQ0603C, AQ105				
		operating temperature	e range -55~+125°C)				
	Applied current	: Rated current ※MC series ;	Idc2max				
	Duration	:500±12 hrs					
	Recovery	:2 to 3 hrs of recovery under the	he standard condition after the test. (See Note 1)				
Note on standard con-	dition: "standard co	ndition" referred to herein is defir	ned as follows:				

5 to $35^{\circ}\!C$ of temperature, 45 to 85% relative humidity, and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20\pm2^{\circ}C$ of temperature, 60 to 70% relative humidity, and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

(Note 1) Measurement shall be made after 48±2 hrs of recovery under the standard condition.

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Precautions on the use of Multilayer chip inductors

Multilayer chip inductors for high frequency, Multilayer chip bead inductors

Multilayer common mode choke coils (MC series F type)

Metal Multilayer Chip Power Inductors (MCOILTM MC series)

PRECAUTIONS

1. Circuit Design

- ◆Verification of operating environment, electrical rating and performance
 - 1. A malfunction in medical equipment, spacecraft, nuclear reactors, etc. may cause serious harm to human life or have severe social ramifications.

As such, any inductors to be used in such equipment may require higher safety and/or reliability considerations and should be clearly

Precautions differentiated from components used in general purpose applications.

- ◆Operating Current(Verification of Rated current)

 1. The operating current including inrush current for inductors must always be lower than their rated values.
- 2. Do not apply current in excess of the rated value because the inductance may be reduced due to the magnetic saturation effect.

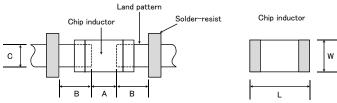
2. PCB Design

Precautions

- ◆Pattern configurations (Design of Land-patterns)
- 1. When inductors are mounted on a PCB, the size of land patterns and the amount of solder used (size of fillet) can directly affect inductor performance.

Therefore, the following items must be carefully considered in the design of solder land patterns:

- (1) The amount of solder applied can affect the ability of chips to withstand mechanical stresses which may lead to breaking or cracking. Therefore, when designing land-patterns it is necessary to consider the appropriate size and configuration of the solder pads which in turn determines the amount of solder necessary to form the fillets.
- (2) When more than one part is jointly soldered onto the same land or pad, the pad must be designed so that each component's soldering point is separated by solder-resist.
- (3) The larger size of land patterns and amount of solder, the smaller Q value after mounting on PCB. It makes higher the Q value to design land patterns smaller than terminal electrode of chips.
- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1. After inductors have been mounted on the boards, chips can be subjected to mechanical stresses in subsequent manufacturing processes (PCB cutting, board inspection, mounting of additional parts, assembly into the chassis, wave soldering the reflow soldered boards etc.) For this reason, planning pattern configurations and the position of SMD inductors should be carefully performed to minimize stress.
- ◆Pattern configurations(Design of Land-patterns)
 - The following diagrams and tables show some examples of recommended patterns to prevent excessive solder amounts (larger fillets which extend above the component end terminations). Examples of improper pattern designs are also shown.
 - (1) Recommended land dimensions for a typical chip inductor land patterns for PCBs



Recommended land dimensions for wave-soldering (Unit:mm)

Ту	ре	1608	2012	2125	2016	2520	3216	
Size	L	1.6	2.0 2.0		2.0 2.5		3.2	
Size	W	0.8	1.25	1.25	1.6	2.0	1.6	
A	4	0.8~1.0	1.0~1.4	1.0~1.4	1.0~1.4	1.0~1.4	1.8~2.5	
Е	3	0.5~0.8	0.8~1.5	0.8~1.5	0.8~1.5	0.6~1.0	0.8~1.7	
()	0.6~0.8	0.9~1.2	0.9~1.2	1.3~1.6	1.6~2.0	1.2~1.6	

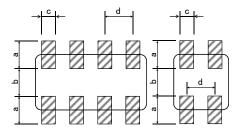
Technical considerations

Recommended land dimensions for reflow-soldering (Unit:mm)

Т	ype	0402	0603	1005	105	1608	2012	2125	2016	2520	3216
Size	L	0.4	0.6	1.0	1.0	1.6	2.0	2.0	2.0	2.5	3.2
Size	W	0.2	0.3	0.5	0.6	0.8	1.25	1.25	1.6	2.0	1.6
	Α	0.15~0.25	0.20~0.30	0.45~0.55	0.50~0.55	0.8~1.0	0.8~1.2	0.8~1.2	0.8~1.2	1.0~1.4	1.8~2.5
	В	0.10~0.20	0.20~0.30	0.40~0.50	0.30~0.40	0.6~0.8	0.8~1.2	0.8~1.2	0.8~1.2	0.6~1.0	0.6~1.5
	С	0.15~0.30	0.25~0.40	0.45~0.55	0.60~0.70	0.6~0.8	0.9~1.6	0.9~1.6	1.2~2.0	1.8~2.2	1.2~2.0

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Excess solder can affect the ability of chips to withstand mechanical stresses. Therefore, please take proper precautions when designing land-patterns.



Recommended land dimension for Reflow-soldering

Type		3216	2010	1210	0806	0605
Size	L	3.2	2.0	1.25	0.85	0.65
	W	1.6	1.0	1.0	0.65	0.50
а		0.7~0.9	0.5~0.6	0.45~0.55	0.25~0.35	0.27~0.33
b		0.8~1.0	0.5~0.6	0.7~0.8	0.25~0.35	0.17~0.23
С		0.4~0.5	0.2~0.3	0.25~0.35	0.25~0.35	0.20~0.26
d		8.0	0.5	0.55	0.5	0.4

(Unit:mm)

((2) Examples of good and bad solder application

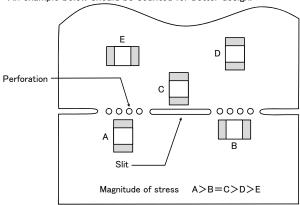
	2 Examples of good and bad solder application				
	Item	Not recommended	Recommended		
Mix	ed mounting of SMD and leaded components	Lead wire of component	Solder-resist		
Com	ponent placement close to the chassis	Chassis Solder (for grounding) Electrode pattern	Solder-resist		
	and-soldering of leaded mponents near mounted components	Lead wire of component Soldering iron	Solder-resist		
	Horizontal component placement		Solder-resist		

- ◆Pattern configurations (Inductor layout on panelized[breakaway] PC boards)
 - 1-1. The following are examples of good and bad inductor layout; SMD inductors should be located to minimize any possible mechanical stresses from board warp or deflection.

Item	Not recommended	Recommended	
Deflection of the board		Position the component at a right angle to the direction of the mechanical stresses that are anticipated.	of

1-2. To layout the inductors for the breakaway PC board, it should be noted that the amount of mechanical stresses given will vary depending on inductor layout.

An example below should be counted for better design.



1-3. When breaking PC boards along their perforations, the amount of mechanical stress on the inductors can vary according to the method used. The following methods are listed in order from least stressful to most stressful: push-back, slit, V-grooving, and perforation. Thus, any ideal SMD inductor layout must also consider the PCB splitting procedure.

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3. Considerations for automatic placement

- ◆Adjustment of mounting machine
 - 1. Excessive impact load should not be imposed on the inductors when mounting onto the PC boards.
 - 2. The maintenance and inspection of the mounter should be conducted periodically.

Precautions

◆ Selection of Adhesives

1. Mounting inductors with adhesives in preliminary assembly, before the soldering stage, may lead to degraded inductor characteristics unless the following factors are appropriately checked; the size of land patterns, type of adhesive, amount applied, hardening temperature and hardening period. Therefore, it is imperative to consult the manufacturer of the adhesives on proper usage and amounts of adhesive to use.

◆Adjustment of mounting machine

- 1. If the lower limit of the pick-up nozzle is low, too much force may be imposed on the inductors, causing damage. To avoid this, the following points should be considered before lowering the pick-up nozzle:
 - (1) The lower limit of the pick-up nozzle should be adjusted to the surface level of the PC board after correcting for deflection of the board.
 - (2) The pick-up pressure should be adjusted between 1 and 3N static loads.
 - (3) To reduce the amount of deflection of the board caused by impact of the pick-up nozzle, supporting pins or back-up pins should be used under the PC board. The following diagrams show some typical examples of good pick-up nozzle placement:

Item	Improper method	Proper method
Single-sided mounting	chipping or cracking	supporting pins or back-up pins
Double-sided mounting	chipping or cracking	supporting pins or back-up pins

Technical considerations

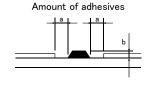
2. As the alignment pin wears out, adjustment of the nozzle height can cause chipping or cracking of the inductors because of mechanical impact on the inductors. To avoid this, the monitoring of the width between the alignment pin in the stopped position, and maintenance, inspection and replacement of the pin should be conducted periodically.

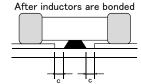
◆Selection of Adhesives

- 1. Some adhesives may cause reduced insulation resistance. The difference between the shrinkage percentage of the adhesive and that of the inductors may result in stresses on the inductors and lead to cracking. Moreover, too little or too much adhesive applied to the board may adversely affect component placement, so the following precautions should be noted in the application of adhesives.
 - (1) Required adhesive characteristics
 - a. The adhesive should be strong enough to hold parts on the board during the mounting & solder process.
 - b. The adhesive should have sufficient strength at high temperatures.
 - c. The adhesive should have good coating and thickness consistency.
 - d. The adhesive should be used during its prescribed shelf life.
 - e. The adhesive should harden rapidly.
 - f. The adhesive must not be contaminated.
 - g. The adhesive should have excellent insulation characteristics.
 - h. The adhesive should not be toxic and have no emission of toxic gasses.
 - (2) When using adhesives to mount inductors on a PCB, inappropriate amounts of adhesive on the board may adversely affect component placement. Too little adhesive may cause the inductors to fall off the board during the solder process. Too much adhesive may cause defective soldering due excessive flow of adhesive on to the land or solder pad.

[Recommended conditions]

Figure	0805 case sizes as examples
а	0.3mm min
b	100∼120 μm
С	Area with no adhesive





4. Soldering

Precautions

◆Selection of Flux

- 1. Since flux may have a significant effect on the performance of inductors, it is necessary to verify the following conditions prior to use;
 - (1) Flux used should be with less than or equal to 0.1 wt% (Chlorine conversion method) of halogenated content. Flux having a strong acidity content should not be applied.
 - (2) When soldering inductors on the board, the amount of flux applied should be controlled at the optimum level.
 - (3) When using water-soluble flux, special care should be taken to properly clean the boards.

◆ Soldering

1. Temperature, time, amount of solder, etc. are specified in accordance with the following recommended conditions, and please contact us about peak temperature when you use lead-free paste.

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◆Selection of Flux

- 1-1. When too much halogenated substance (Chlorine, etc.) content is used to activate the flux, or highly acidic flux is used, an excessive amount of residue after soldering may lead to corrosion of the terminal electrodes or degradation of insulation resistance on the surface of the Inductor.
- 1-2. Flux is used to increase solderability in flow soldering, but if too much is applied, a large amount of flux gas may be emitted and may detrimentally affect solderability. To minimize the amount of flux applied, it is recommended to use a flux-bubbling system.
- 1-3. Since the residue of water-soluble flux is easily dissolved by water content in the air, the residue on the surface of Inductor in high humidity conditions may cause a degradation of insulation resistance and therefore affect the reliability of the components. The cleaning methods and the capability of the machines used should also be considered carefully when selecting water-soluble flux.

Soldering

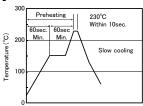
1-1. Preheating when soldering

Heating: Chip inductor components should be preheated to within $100 \text{ to } 130^{\circ}\text{C}$ of the soldering. Cooling: The temperature difference between the components and cleaning process should not be greater than 100°C .

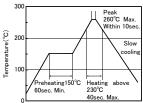
Chip inductors are susceptible to thermal shock when exposed to rapid or concentrated heating or rapid cooling. Therefore, the soldering process must be conducted with a great care so as to prevent malfunction of the components due to excessive thermal shock.

[Reflow soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]



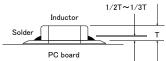
- m %Ceramic chip components should be preheated to within 100 to 130°C of the soldering.
- *Assured to be reflow soldering for 2 times.
- *MC series; Peak 230°C(eutectic soldering), 260°C(Pb-free soldering)max within 5sec.

Caution

Technical

considerations

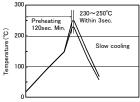
1. The ideal condition is to have solder mass (fillet) controlled to 1/2 to 1/3 of the thickness of the inductor, as shown below:



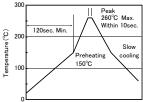
2. Because excessive dwell times can detrimentally affect solderability, soldering duration should be kept as close to recommended times as possible.

[Wave soldering]

[Recommended conditions for eutectic soldering]



[Recommended condition for Pb-free soldering]



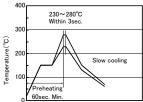
- $\rm \% Ceramic \ chip \ components \ should \ be \ preheated \ to \ within \ 100 \ to \ 130 \ C$ of the soldering.
- XAssured to be wave soldering for 1 time.
- Except for reflow soldering type

Caution

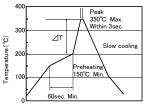
- 1. Make sure the inductors are preheated sufficiently.
- 2. The temperature difference between the inductor and melted solder should not be greater than 100 to 130° C.
- 3. Cooling after soldering should be as gradual as possible.
- 4. Wave soldering must not be applied to the inductors designated as for reflow soldering only.

[Hand soldering]

[Recommended conditions for eutectic soldering



[Recommended condition for Pb-free soldering]



- (**※**⊿T≦190°C(3216Type max), ⊿T≦130°C(3225 Type min)
- \times It is recommended to use 20W soldering iron and the tip is 1 ϕ or less.
- XThe soldering iron should not directly touch the components.
- *Assured to be soldering iron for 1 time

Note: The above profiles are the maximum allowable soldering condition, therefore these profiles are not always recommended.

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Caution 1. Use a 20W soldering iron with a maximum tip diameter of 1.0 mm. 2. The soldering iron should not directly touch the inductor.

5. Cleaning Cleaning conditions 1. When cleaning the PC board after the Inductors are all mounted, select the appropriate cleaning solution according to the type of flux used and purpose of the cleaning(e.g. to remove soldering flux or other materials from the production process.) 2. Cleaning conditions should be determined after verifying, through a test run, that the cleaning process does not affect the inductor's characteristics. Cleaning conditions 1. The use of inappropriate solutions can cause foreign substances such as flux residue to adhere to the inductor, resulting in a degradation of the inductor's electrical properties(especially insulation resistance). 2. Inappropriate cleaning conditions (insufficient or excessive cleaning) may detrimentally affect the performance of the inductors. (1) Excessive cleaning

Technical considerations

a. In the case of ultrasonic cleaning, too much power output can cause excessive vibration of the PC board which may lead to the cracking of the inductor or the soldered portion, or decrease the terminal electrodes' strength. Thus the following conditions should be carefully checked;

Ultrasonic output Below 20W/2
Ultrasonic frequency Below 40kHz
Ultrasonic washing period 5 min. or less

6. Post cleaning processes

◆Application of resin coatings, moldings, etc. to the PCB and components.

Precautions

- 1. With some type of resins a decomposition gas or chemical reaction vapor may remain inside the resin during the hardening period or while left under normal storage conditions resulting in the deterioration of the inductor's performance.
- 2. When a resin's hardening temperature is higher than the inductor's operating temperature, the stresses generated by the excess heat may lead to inductor damage or destruction.
- 3. Stress caused by a resin's temperature generated expansion and contraction may damage inductors.

The use of such resins, molding materials etc. is not recommended.

7. Handling

- ◆Breakaway PC boards (splitting along perforations)
 - 1. When splitting the PC board after mounting inductors and other components, care is required so as not to give any stresses of deflection or twisting to the board.
 - 2. Board separation should not be done manually, but by using the appropriate devices.
- ♦ General handling precautions
 - 1. Always wear static control bands to protect against ESD.
 - $\ensuremath{\mathbf{2}}.$ Keep the inductors away from all magnets and magnetic objects.
- Precautions
- 3. Use non-magnetic tweezers when handling inductors.4. Any devices used with the inductors (soldering irons, measuring instruments) should be properly grounded.
- 5. Keep bare hands and metal products (i.e., metal desk) away from chip electrodes or conductive areas that lead to chip electrodes.
- 6. Keep inductors away from items that generate magnetic fields such as speakers or coils.
- ◆Mechanical considerations
 - 1. Be careful not to subject the inductors to excessive mechanical shocks.
 - (1) If inductors are dropped on the floor or a hard surface they should not be used.
 - (2) When handling the mounted boards, be careful that the mounted components do not come in contact with or bump against other boards or components.

8. Storage conditions

♦Storage

1. To maintain the solderability of terminal electrodes and to keep the packaging material in good condition, care must be taken to control temperature and humidity in the storage area. Humidity should especially be kept as low as possible.

Recommended conditions

Ambient temperature Below 30°C

Humidity Below 70% RH

The ambient temperature must be kept below 40°C. Even under ideal storage conditions inductor electrode solderability decreases as time passes, so inductors should be used within 6 months from the time of delivery.

*The packaging material should be kept where no chlorine or sulfur exists in the air.

◆Storage

Technical considerations

Precautions

1. If the parts are stocked in a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place. For this reason, components should be used within 6 months from the time of delivery. If exceeding the above period, please check solderability before using the inductors.

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